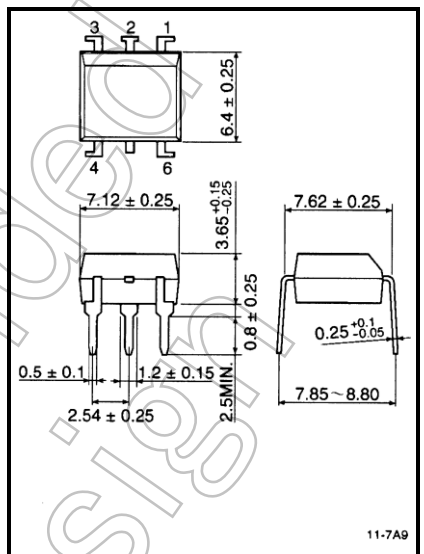
TOSHIBA PHOTOCOUPLER GaAs IRED & PHOTO-TRIAC

TLP665J(S)

Unit: mm



JEDEC	–
TOSHIBA	11-7A9

Weight: 0.39 g (typ.)

Office Equipment
Household Appliances
Triac Drivers
Solid State Relays

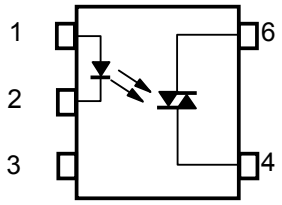
The TOSHIBA TLP665J(S) consists of a gallium arsenide infrared emitting diode optically coupled to a triac-output photocoupler housed in a 6-pin DIP package.

- Peak Off-State Voltage: 600 V (min)
- Trigger LED Current:10 mA (max)
- On-State Current: 100 mA (max)
- Isolation Voltage: 5000 Vrms (min)
- UL approved: UL1577, File No.E67349
- cUL approved :CSA Component Acceptance Service No. 5A, File No.E67349
- CQC approved: GB4943.1,GB8898 Japan Factory
- Option (D4) VDE approved : DIN EN60747-5-5 ,EN60065,EN60950-1 (Note1)
  EN62368-1(Pending) (Note1)

(Note 1) : When a EN60747-5-5 approved type is needed, please designate "Option(D4)"

Maximum operating insulation voltage: 890 V_{PK}
Maximum permissible overvoltage: 8000 V_{PK}

Pin Configuration (top view)



1: Anode
2: Csthode
3: N.C.
4:TriacTerminal
6:TriacTerminal

- Construction Mechanical Rating

	7.62 mm pitch Standard Type	10.16 mm pitch TLPxxxxF Type
Creepage Distance	7.0 mm (min)	8.0 mm (min)
Clearance	7.0 mm (min)	8.0 mm (min)
Insulation Thickness	0.5 mm (min)	0.5 mm (min)

Start of commercial production
1987-06

Absolute Maximum Ratings (Ta=25°C)

CHARACTERISTIC			SYMBOL	RATING	UNIT
LED	Forward Current		I_F	50	mA
	Forward Current Derating (Ta ≥ 53°C)		ΔI_F /°C	−0.7	mA /°C
	Peak Forward Current (100 μs pulse, 100 pps)		I_{FP}	1	A
	Reverse Voltage		V_R	5	V
	Power Dissipation		P_D	100	mW
	Power Dissipation Derating (Ta ≥ 53°C)		ΔP_D /°C	-1.4	mW/°C
	Junction Temperature		T_j	125	°C
DETECTOR	Off-State Output Terminal Voltage		V_{DRM}	600	V
	On-State RMS Current	Ta=25°C	$I_{T(RMS)}$	100	mA
		Ta=70°C		50	
	On-State Current Derating (Ta ≥ 25°C)		ΔI_T/°C	-1.1	mA /°C
	Peak On-State Current (100 μs pulse, 120 pps)		I_{TP}	2	A
	Peak Nonrepetitive Surge Current (Pw=10 ms)		I_{TSM}	1.2	A
	Output Power Dissipation		P_O	300	mW
	Output Power Dissipation Derating (Ta ≥ 25°C)		ΔP_O /°C	-3.0	mW/°C
	Junction Temperature		T_j	115	°C
Storage Temperature Range			T_{stg}	−55 to 125	°C
Operating Temperature Range			T_{opr}	−40 to 100	°C
Lead Soldering Temperature (10 s)			T_{sol}	260	°C
Total Package Power Dissipation			P_T	330	mW
Total Package Power Dissipation Derating (Ta ≥ 25°C)			ΔP_T/°C	-4.4	mW /°C
Isolation Voltage (AC, 1minute, R.H.≤ 60%) (Note 2)			BV_S	5000	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook (“Handling Precautions”/“Derating Concept and Methods”) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

(Note 2) Device considered a two terminal device :Pins1, 2 and 3 shorted together and pin 4 and pin 6 shorted together.

Recommended Operating Conditions

CHARACTERISTIC	SYMBOL	MIN	TYP.	MAX	UNIT
Supply Voltage	V_{AC}	—	—	240	V_{ac}
Forward Current	I_F	15	20	25	mA
Peak On-State Current	I_{TP}	—	—	1	A
Operating Temperature	T_{opr}	−25	—	85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

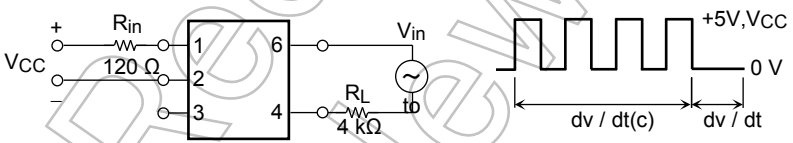
Individual Electrical Characteristics (Ta=25°C)

	CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
LED	Forward Voltage	V_F	I_F = 10 mA	1.0	1.15	1.3	V
	Reverse Current	I_R	V_R = 5 V	—	—	10	μA
	Capacitance	C_T	VF = 0 V, f=1 MHz	—	30	—	pF
DETECTOR	Peak Off-State Current	I_{DRM}	V_{DRM} = 600 V	—	10	1000	nA
	Peak On-State Voltage	V_{TM}	I_{TM} = 100 mA	—	1.7	3.0	V
	Holding Current	I_H	—	—	1.0	—	mA
	Critical Rate of Rise of Off-State Voltage	dv/dt	V_{in} = 240 Vrms, Ta=85°C (Fig.1)	—	500	—	V/μs
	Critical Rate of Rise of Commutating Voltage	dv/dt(c)	V_{in} = 60 Vrms, I_T=15 mA (Fig.1)	—	0.2	—	V/μs

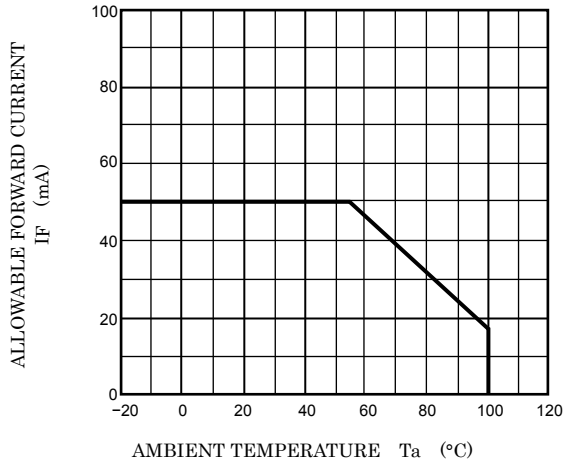
Coupled Electrical Characteristics (Ta=25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Trigger LED Current	I_{FT}	V_T=6 V	—	5	10	mA
Capacitance (Input to Output)	C_S	VS=0 V, f=1 MHz	—	0.8	—	pF
Isolation Resistance	R_S	VS=500 V (R.H.≤ 60%)	5×10^{10}	10^{14}	—	Ω
Isolation Voltage	BV_S	AC, 1 minute	5000	—	—	Vrms
		AC, 1 second, in oil	—	10000	—	
		DC, 1 minute, in oil	—	10000	—	Vdc

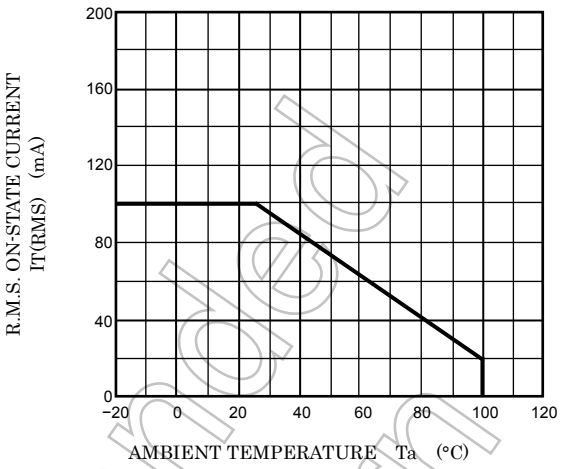
Fig. 1 dv / dt test circuit



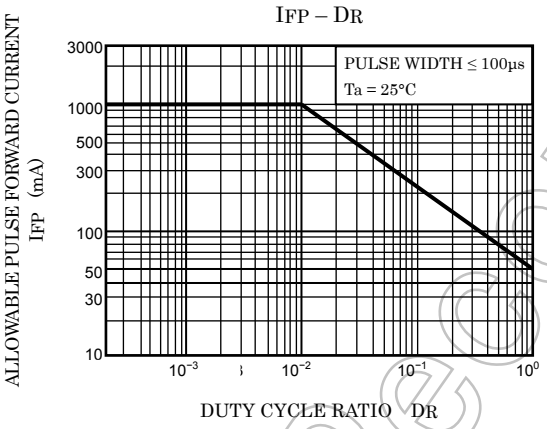
I_F – Ta



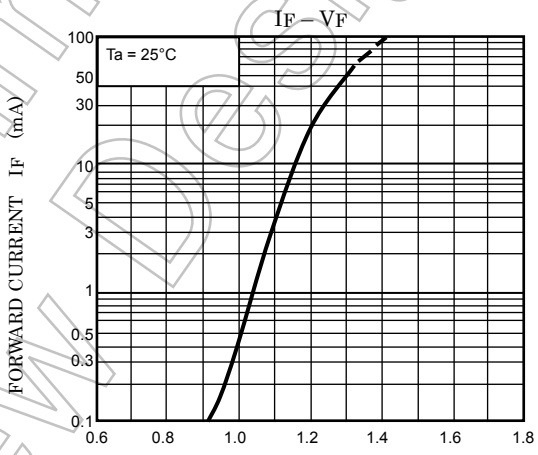
$I_{T(RMS)}$ – Ta



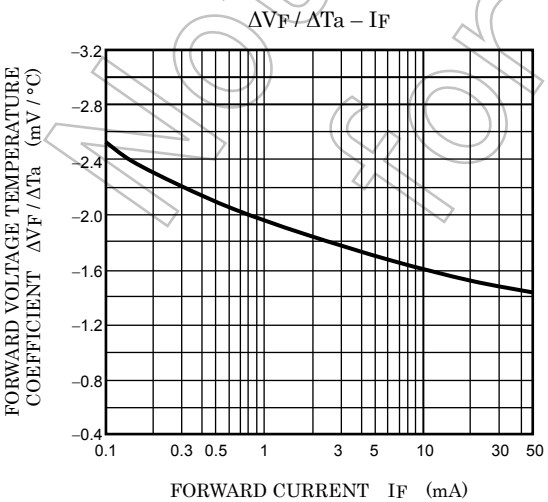
I_{FP} – D_R



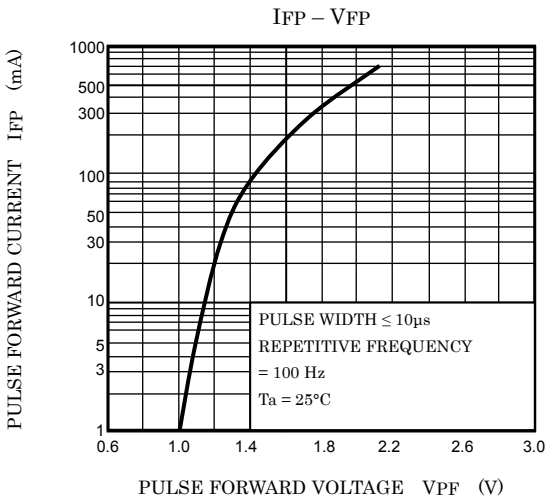
I_F – V_F



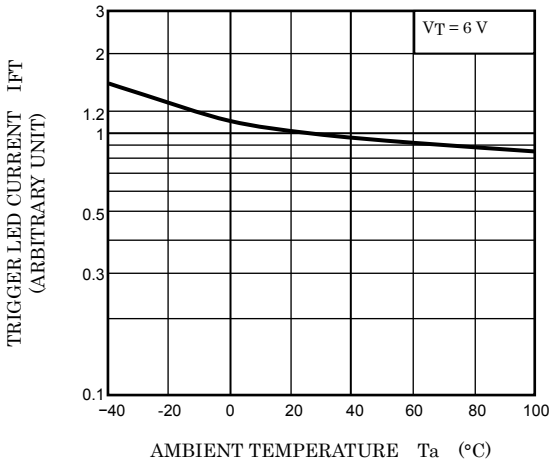
$\Delta V_F / \Delta Ta$ – I_F



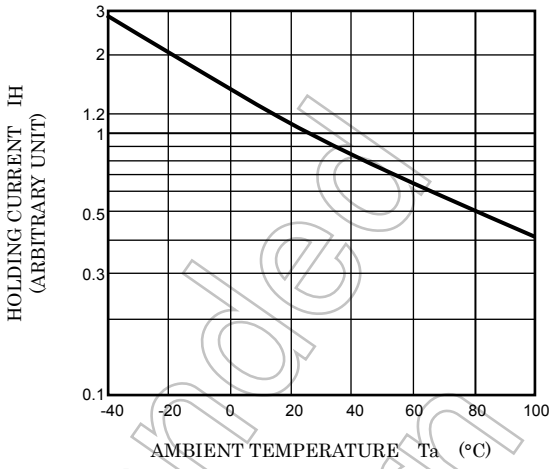
I_{FP} – V_{FP}



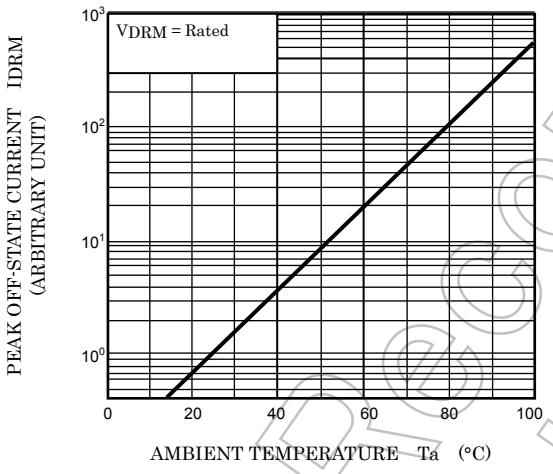
NORMALIZED I_{FT} – Ta



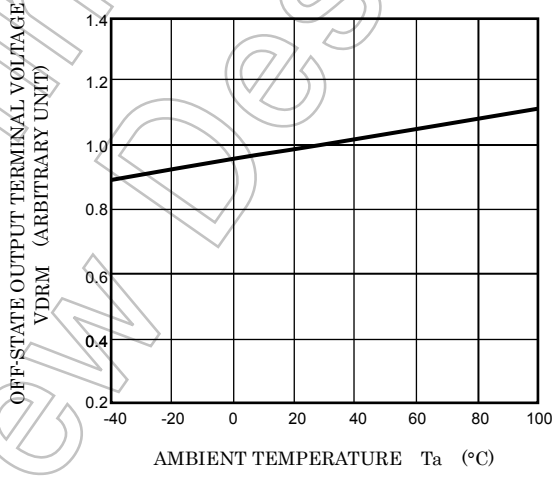
NORMALIZED I_H – Ta



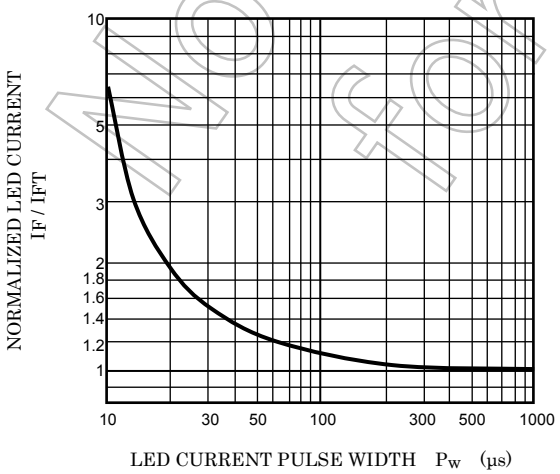
NORMALIZED I_{DRM} – Ta



NORMALIZED V_{DRM} – Ta



NORMALIZED I_F / I_{FT} – P_W



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